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Diodes Incorporated DMG4407SSS-13

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Datasheet of DMG4407SSS-13 - MOSFET P-CH 30V 9.9A 8-SO

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DMG4407SSS

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C		
-30V	$11m\Omega$ @ $V_{GS} = -20V$	-9.9A		
-307	$17m\Omega$ @ $V_{GS} = -6V$	-8.2A		

Description

This MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

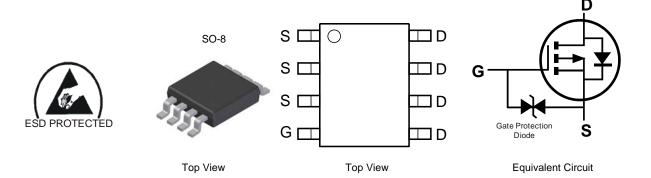
- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.075 grams (approximate)



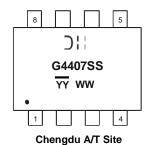
Ordering Information (Note 4)

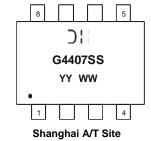
Part Number	Case	Packaging
DMG4407SSS-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





OH = Manufacturer's Marking
G4407SS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 13 = 2013)
WW = Week (01 - 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Prain Current (Note C) / 201/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	-9.9 -7.9	А
Continuous Drain Current (Note 6) V _{GS} = -20V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	-12.5 -10.0	А
Continuous Prain Current (Note C) V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	l _D	-8.2 -6.5	А
Continuous Drain Current (Note 6) V _{GS} = -6V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-11.0 -8.7	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3.0	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-80	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	P_D	1.45	W	
The second Designation to Applicate (New Steady		D	88	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	50	°C/W
Total Power Dissipation (Note 6)	P_{D}	1.82	W	
Thermal Resistance, Junction to Ambient (Note 6) Stead tc		$R_{\theta JA}$	70	°C/W
			41	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	7.6	°C/W	
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-50 to 155	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

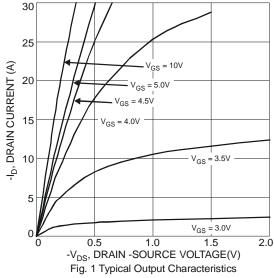
	,						
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±10	μΑ	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-1.7		-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
			9	11	mΩ	$V_{GS} = -20V, I_D = 12A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	10	13		$V_{GS} = -10V, I_D = 10A$	
	, ,	_	12.7	17		$V_{GS} = -6V, I_D = 10A$	
Forward Transfer Admittance	Y _{fs}	_	21	_	S	$V_{DS} = -5V, I_{D} = -10A$	
Diode Forward Voltage		_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	2246		pF	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	352	_	pF		
Reverse Transfer Capacitance	Crss	_	294	_	pF	1 = 1:0W112	
Gate resistance	Rg	_	5.1	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	20.5	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q_g	_	41		nC	$V_{GS} = -10V, V_{DS} = -15V,$ $I_{D} = -12A$	
Gate-Source Charge	Q_{gs}	_	7.6	_	nC		
Gate-Drain Charge	Q_{gd}	_	8.0	_	nC		
Turn-On Delay Time	t _{D(on)}	_	11.3	_	ns		
Turn-On Rise Time	t _r	_	15.4	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$	
urn-Off Delay Time t _{D(off)} -		_	38.0	_	ns	$R_L = 1.25\Omega$, $R_G = 3\Omega$,	
Turn-Off Fall Time	t _f	_	22.0	_	ns	\neg	

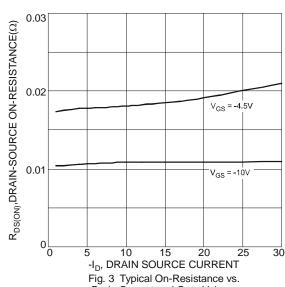
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:

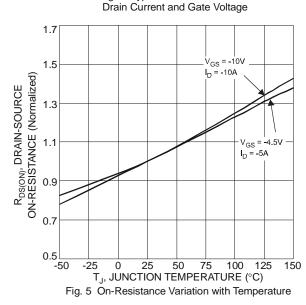
8. Guaranteed by design. Not subject to product testing.

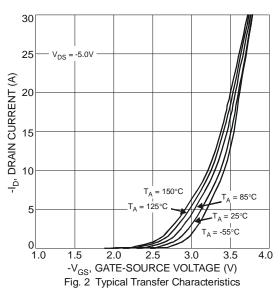


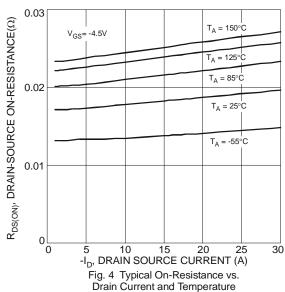
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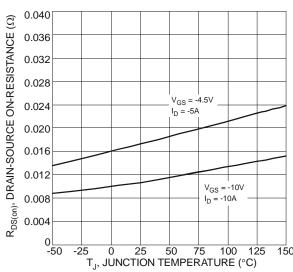














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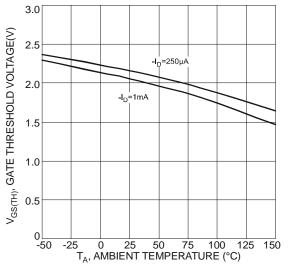


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

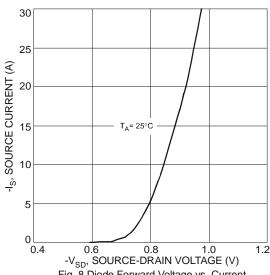
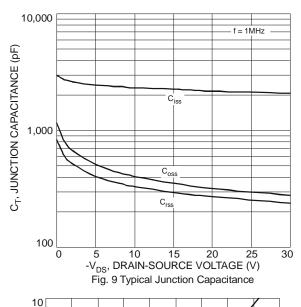


Fig. 8 Diode Forward Voltage vs. Current



-V_{GS}, GATE-SOURCE VOLTAGE (V) √_{DS} = -15√ I_D = -12A

10 15 20 25 30 35 Q_g, TOTAL GATE CHARGE (nC)

Fig. 11 Gate-Charge Characteristics

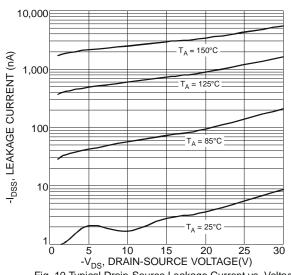
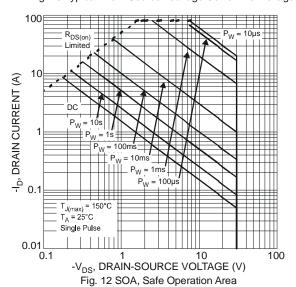


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage



0

0

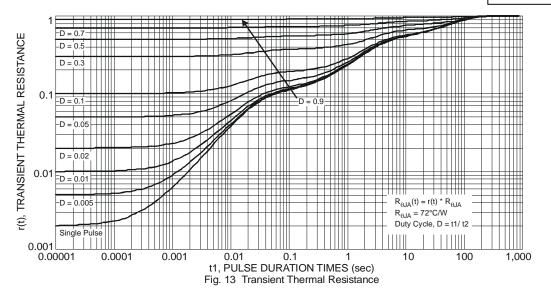
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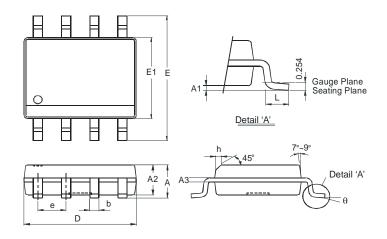


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Package Outline Dimensions

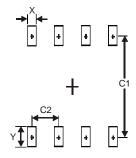
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8						
Dim	Min	Max				
Α	-	1.75				
A1	0.10	0.20				
A2	1.30	1.50				
А3	0.15	0.25				
b	0.3	0.5				
D	4.85	4.95				
Е	5.90	6.10				
E1	3.85	3.95				
е	e 1.27 Typ					
h	-	0.35				
L	0.62	0.82				
θ	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)			
Х	0.60			
Υ	1.55			
C1	5.4			
C2	1.27			



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